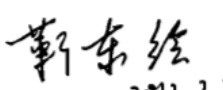
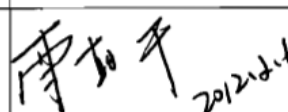

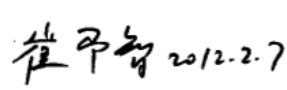


Product Specification

Product Name: VGM128064A0G01

Product Code: M00012

Customer
Approved by Customer
Approved Date:

Designed By	Checked By	Approved By	
		R&D	QA
 2012.2.2	 2012.2.6	 2012.2.6	 2012.2.7

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REVISION RECORD

REV.	REVISION DESCRIPTION	REV. DATE	REMARK
E01	Initial release.	2008-11-05	
Y01	Update content.	2009-04-16	
Y02	Update content.	2010-4-29	Page 4,5,9, 14,15,16, 17,18
A01	Update the Mechanical Data Update the Absolute Maximum Ratings Update the Electro-optical Characteristics Update the Application Circuit(Add the 6800/SPI/I ² C interface mode) Add the External DC-DC application circuit Update the Package Specification Update the Reliability Test Update the Lifetime	2012-02-02	Page 4 Page 8 Page 9 Page 15~18 Page 19 Page 21 Page 22 Page 22

1 Overview

VGM128064A0G01 is a monochrome OLED display module with 128×64 dot matrix. The characteristics of this display module are high brightness, self-emission, high contrast ratio, slim/thin outline, wide viewing angle, wide temperature range, and low power consumption.

2 Features

- Display Color: Green
- Dot Matrix:128×64
- Driver IC: SSD1305T7R1
- Interface:8-bit 8080,8-bit 6800, SPI, I²C
- Wide range of operating temperature: -40°C to 70°C

3 Mechanical Data

NO.	ITEM	SPECIFICATION	UNIT
1	Dot Matrix	128(W)×64(H)	-
2	Dot Size	0.455(W)×0.455 (H)	mm ²
3	Dot Pitch	0.48(W)×0.48 (H)	mm ²
4	Aperture Rate	90	%
5	Active Area	61.41(W)×30.69 (H)	mm ²
6	Panel Size	73.0(W)×41.86 (H) ×1.8(T)	mm ³
7	Module Size	73.0(W)×56.66 (H) ×2.03(T)	mm ³
8	Diagonal A/A Size	2.70	inch
9	Module Weight	12.92 ± 10%	gram

4 Mechanical Drawing

If the seal is not red, then it indicated that the document is not control version, which won't be controlled and updated. Please use controlled version. Distribution No. _____

Controlled seal

Specification

1. Display: OLED (Green)
2. Format: 128*64
3. Driver IC: SSD1305TR1
4. General Tolerance: ±0.3
5. Operate temp: -40° C ~ 70° C
- Storage temp: -40° C ~ 85° C
6. DUTY: 1/64
7. RoHS Compliant

Pin Assignment

NO.	SYMBOL
1	NC
2	VCC
3	VCOMH
4	IREF
5	D7
6	D6
7	D5
8	D4
9	D3
10	D2
11	D1
12	D0
13	RD
14	R/W
15	D/C
16	RES
17	CS
18	NC
19	BS2
20	BS1
21	VDD
22	NC
23	NC
24	NC
25	VBRPF
26	NC
27	FB
28	VDDP
29	GDR
30	VSS
31	NC

Customer Approval	Signature
Part Name	Module ass'y
Project Code	00012
Part No.	00012-MA1-A

Date	2010.04.28
Rev.	03
Unit	mm
Sheet	1/1

3rd Angle Projection

Rev.	Date	Note
1	2008-11-14	Primary
2	2010.04.12	Change the type of polarizer
3	2010.04.28	Change operate temperature and storage temperature

E-mail: sales@visionox.com

http://www.visionox.com

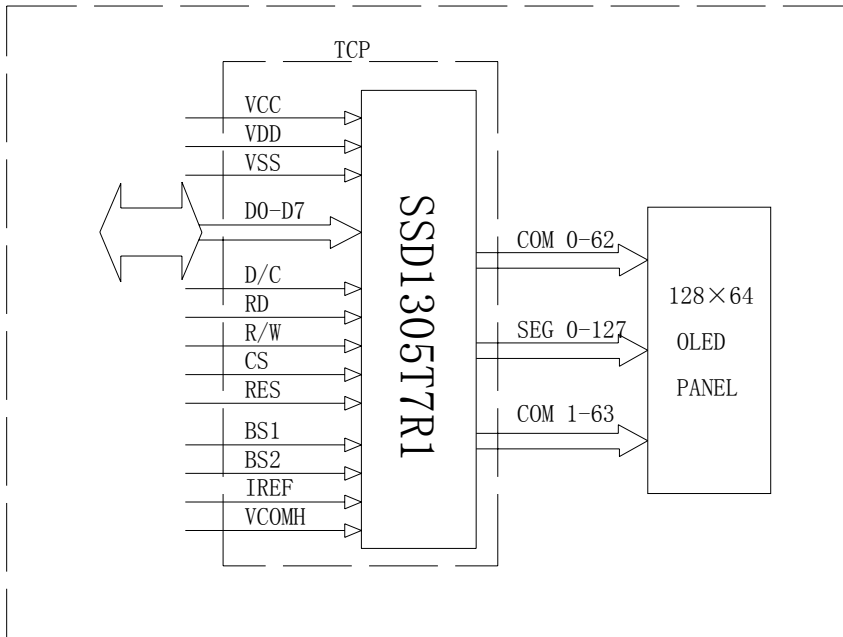
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5 Module Interface

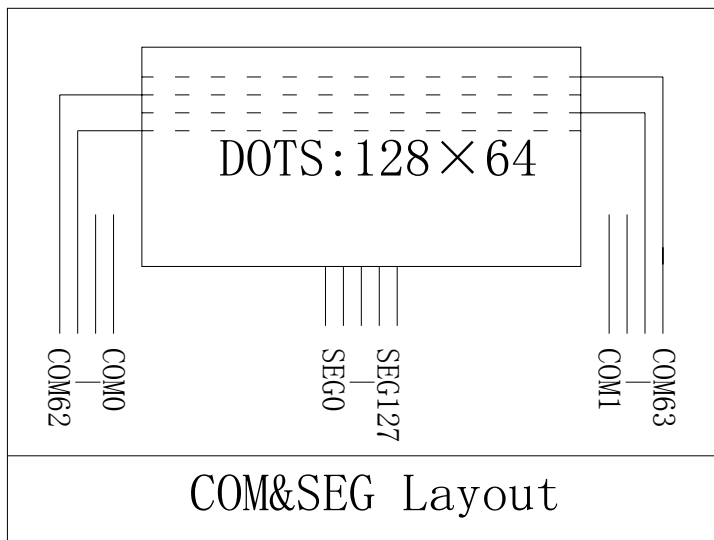
PIN NO.	PIN NAME	DESCRIPTION															
1	NC	No Connection.															
2	VCC	OLED drive voltage, it should be supplied externally.															
3	VCOMH	This is an input pin for the voltage output high level for COM signals. A capacitor should be connected between this pin and VSS.															
4	IREF	This is a segment current reference pin. A resistor should be connected between this pin and VSS. Set the current at 10uA.															
5	D7	<p>These are 8-bit bi-directional data bus to be connected to the microprocessor's data bus. When serial interface mode is selected, D0 will be the serial clock input, SCLK; D1 will be the serial data input: SDIN and D2 should be left opened. When I²C mode is selected, D2, D1 should be tied together and served as SDA_{out}, SDA_{in} in application and D0 is the serial clock input, SCL.</p>															
6	D6																
7	D5																
8	D4																
9	D3																
10	D2																
11	D1																
12	D0																
13	RD	This is a MCU interface input pin. 8080: data read enable pin; 6800: Read/Write enable pin.															
14	R/W	This is a MCU interface input pin. 8080: data write enable pin; 6800: Read/Write select pin.															
15	D/C	Data/Command Select. H: Data; L: Command.															
16	RES	Reset, active low.															
17	CS	Chip Select, active low.															
18	NC	No Connection.															
19	BS2	<p>These are MCU interface input selection pins. See the following table for selecting different interfaces:</p> <table border="1" style="margin-left: auto; margin-right: auto;"> <thead> <tr> <th>Pin Name</th> <th>I²C Interface</th> <th>6800-parallel Interface</th> <th>8080-parallel interface</th> <th>Serial Interface</th> </tr> </thead> <tbody> <tr> <td>BS1</td> <td>1</td> <td>0</td> <td>1</td> <td>0</td> </tr> <tr> <td>BS2</td> <td>0</td> <td>1</td> <td>1</td> <td>0</td> </tr> </tbody> </table>	Pin Name	I ² C Interface	6800-parallel Interface	8080-parallel interface	Serial Interface	BS1	1	0	1	0	BS2	0	1	1	0
Pin Name	I ² C Interface		6800-parallel Interface	8080-parallel interface	Serial Interface												
BS1	1		0	1	0												
BS2	0	1	1	0													
20	BS1																
21	VDD	Power supply pin for core logic operation.															
22	NC	No connection.															
23	NC																
24	NC																
25	VBREF	Reserved pin; No connection and left float.															
26	NC	No connection.															
27	FB	This is a reserved pin. It should be kept NC (i.e. Float during normal operation).															
28	VDDB	This is a reserved pin. It must be connected to VDD.															
29	GDR	This is a reserved pin. It should be kept NC (i.e. Float during normal operation).															
30	VSS	Ground.															
31	NC	No Connection.															

6 Function Block Diagram

6.1 Function Block Diagram



6.2 Panel Layout Diagram



7 Absolute Maximum Ratings

ITEM	SYMBOL	MIN	MAX	UNIT	REMARK
Logic supply voltage	V_{DD}	-0.3	+4.0	V	IC maximum rating
OLED Operating voltage	V_{CC}	0	+16	V	IC maximum rating
Operating Temp.	Top	-40	+70	°C	-
Storage Temp	Tstg	-40	+85	°C	-

Note (1): All of the voltages are on the basis of “VSS = 0V”.

Note (2): Permanent breakage of module may occur if the module is used beyond the maximum rating. The module can be normal operated under the conditions according to Section 8 “Electrical Characteristics”. Malfunctioning of the module may occur and the reliability of the module may deteriorate if the module is used beyond the conditions.

8 Electrical Characteristics

8.1 DC Electrical Characteristics

ITEM	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNIT
Logic Supply Voltage	V_{DD}	22±3°C, 55±15%R.H	2.4	3.0	3.5	V
OLED Driver Supply Voltage	V_{CC}	22±3°C, 55±15%R.H	11.5	12	12.5	V
High-level Input Voltage	V_{IH}	-	$0.8 \times V_{DD}$	-	-	V
Low-level Input Voltage	V_{IL}	-	0	-	$0.2 \times V_{DD}$	V
High-level Output Voltage	V_{OH}	-	$0.9 \times V_{DD}$	-	-	V
Low-level Output Voltage	V_{OL}	-	0	-	$0.1 \times V_{DD}$	V

Note : The V_{CC} input must be kept in a stable value; ripple and noise are not allowed.

8.2 Electro-optical Characteristics

ITEM	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNIT
Normal Mode Brightness	L_{br}	All pixels ON(1)	40	60	-	cd/m ²
Normal Mode Power Consumption	P_t	All pixels ON(1)	-	300	360	mW
I_{CC} Sleep mode Current	$I_{CC, SLEEP}$	$V_{DD} = 2.4V \sim 3.5V$, $V_{CC} = 7V \sim 15V$ Display OFF, No panel attached	-	-	10	uA
I_{DD} Sleep mode Current	$I_{DD, SLEEP}$	$V_{DD} = 2.4V \sim 3.5V$, $V_{CC} = 7V \sim 15V$ Display OFF, No panel attached	-	-	10	uA
C.I.E(Green)	(x)	x,y(CIE1931)	0.27	0.31	0.35	-
	(y)		0.56	0.60	0.64	-
Dark Room Contrast	CR	-	$\geq 2000:1$	-	-	-
Response Time	-	-	---	10	-	μs
View Angle	-	-	≥ 160	-	-	Degree

Note(1): Normal Mode test conditions are as follows:

- Driving voltage : 12V
- Contrast setting : 0x5b
- Frame rate : 105Hz
- Duty setting : 1/64

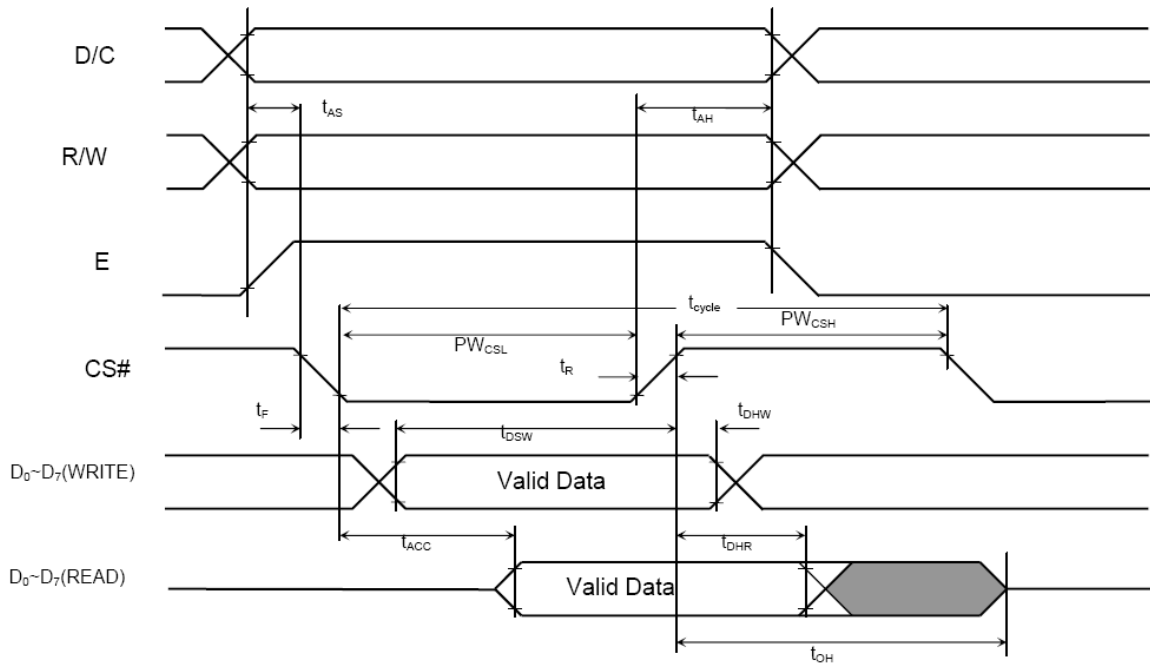
8.3 AC Electrical Characteristics

(1)6800-Series MPU Parallel Interface Timing Characteristics

(VDD - VSS = 2.4V to 3.5V, TA = 25°C)

Symbol	Parameter	Min	Typ	Max	Unit
t_{cycle}	Clock Cycle Time	300	-	-	ns
t_{AS}	Address Setup Time	0	-	-	ns
t_{AH}	Address Hold Time	0	-	-	ns
t_{DSW}	Write Data Setup Time	40	-	-	ns
t_{DHW}	Write Data Hold Time	7	-	-	ns
t_{DHR}	Read Data Hold Time	20	-	-	ns
t_{OH}	Output Disable Time	-	-	70	ns
t_{ACC}	Access Time	-	-	140	ns
PW_{CSL}	Chip Select Low Pulse Width (read) Chip Select Low Pulse Width (write)	120 60	-	-	ns
PW_{CSH}	Chip Select High Pulse Width (read) Chip Select High Pulse Width (write)	60 60	-	-	ns
t_R	Rise Time	-	-	40	ns
t_F	Fall Time	-	-	40	ns

6800-series MCU parallel interface characteristics

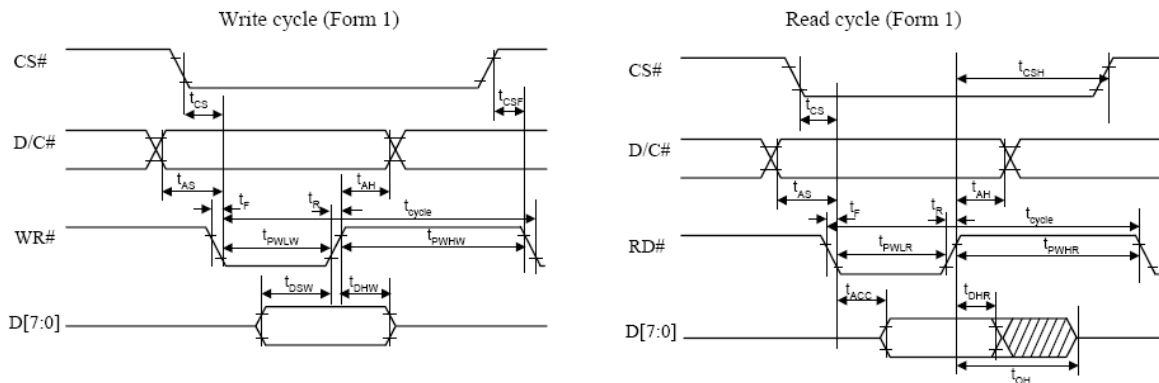


(2)8080-Series MPU Parallel Interface Timing Characteristics

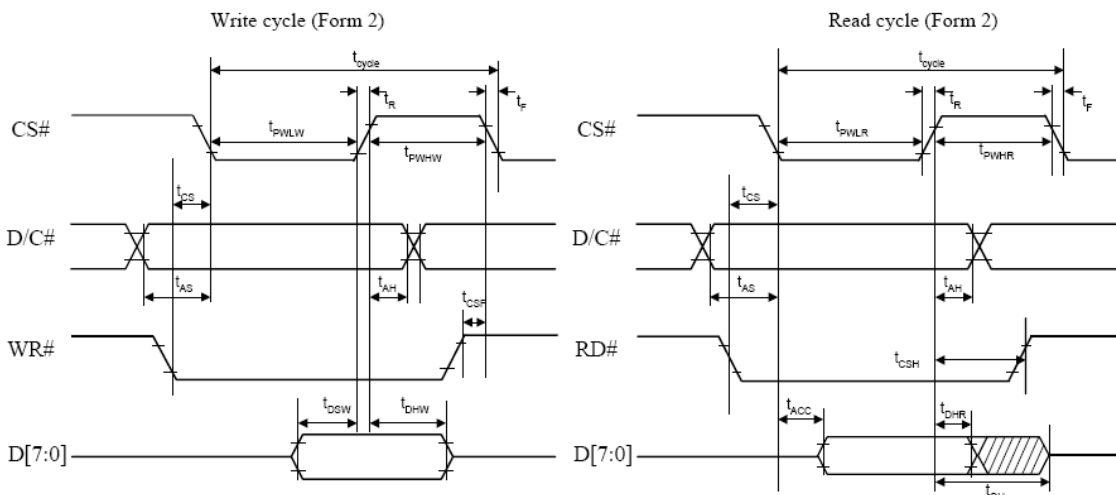
(VDD - VSS = 2.4V to 3.5V, TA = 25°C)

Symbol	Parameter	Min	Typ	Max	Unit
t_{cycle}	Clock Cycle Time	300	-	-	ns
t_{AS}	Address Setup Time	10	-	-	ns
t_{AH}	Address Hold Time	0	-	-	ns
t_{DSW}	Write Data Setup Time	40	-	-	ns
t_{DHW}	Write Data Hold Time	7	-	-	ns
t_{DHR}	Read Data Hold Time	20	-	-	ns
t_{OH}	Output Disable Time	-	-	70	ns
t_{ACC}	Access Time	-	-	140	ns
t_{PWLR}	Read Low Time	120	-	-	ns
t_{PWLW}	Write Low Time	60	-	-	ns
t_{PWHR}	Read High Time	60	-	-	ns
t_{PWHW}	Write High Time	60	-	-	ns
t_R	Rise Time	-	-	40	ns
t_F	Fall Time	-	-	40	ns
t_{CS}	Chip select setup time	0	-	-	ns
t_{CSH}	Chip select hold time to read signal	0	-	-	ns
t_{CSF}	Chip select hold time	20	-	-	ns

8080-series parallel interface characteristics (Form 1)



8080-series parallel interface characteristics (Form 2)

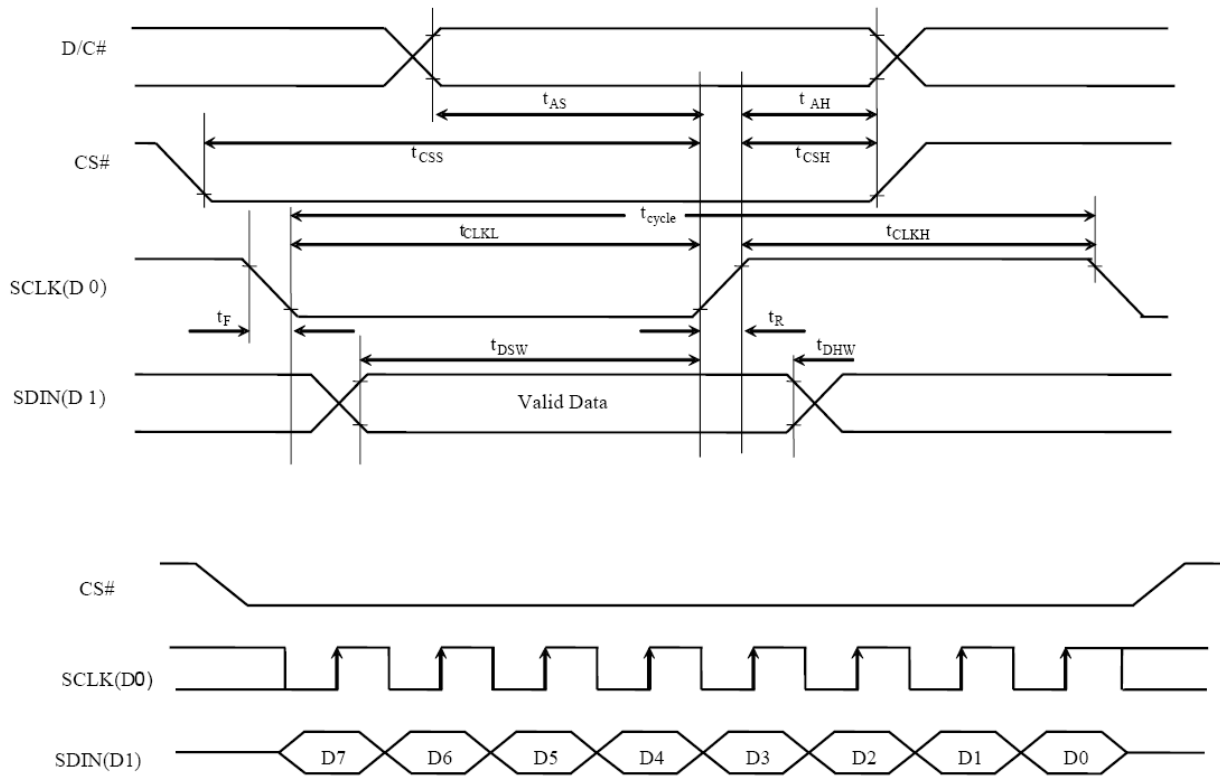


(3)Serial Interface Timing Characteristics

(VDD - VSS = 2.4V to 3.5V, TA = 25°C)

Symbol	Parameter	Min	Typ	Max	Unit
t_{cycle}	Clock Cycle Time	250	-	-	ns
t_{AS}	Address Setup Time	150	-	-	ns
t_{AH}	Address Hold Time	150	-	-	ns
t_{CSS}	Chip Select Setup Time	120	-	-	ns
t_{CSH}	Chip Select Hold Time	60	-	-	ns
t_{DSW}	Write Data Setup Time	50	-	-	ns
t_{DHW}	Write Data Hold Time	15	-	-	ns
t_{CLKL}	Clock Low Time	100	-	-	ns
t_{CLKH}	Clock High Time	100	-	-	ns
t_R	Rise Time	-	-	40	ns
t_F	Fall Time	-	-	40	ns

Serial interface characteristics

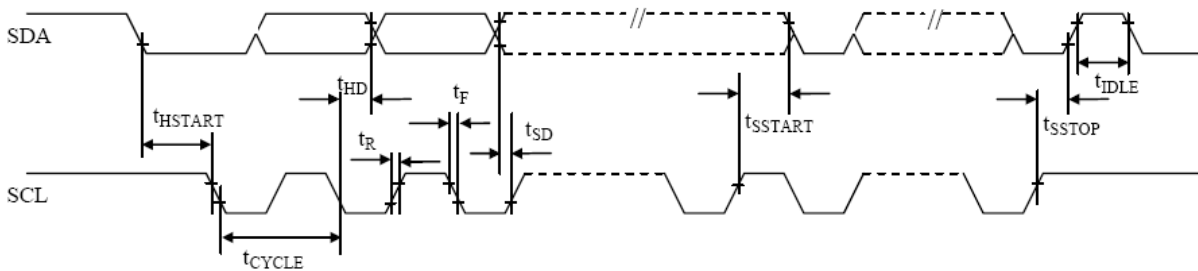


(4) I²C interface Timing Characteristics

(VDD - VSS = 2.4V to 3.5V, TA = 25°C)

Symbol	Parameter	Min	Typ	Max	Unit
t _{cycle}	Clock Cycle Time	2.5	-	-	us
t _{HSTART}	Start condition Hold Time	0.6	-	-	us
t _{HD}	Data Hold Time (for “SDA _{OUT} ” pin)	0	-	-	ns
	Data Hold Time (for “SDA _{IN} ” pin)	300	-	-	ns
t _{SD}	Data Setup Time	100	-	-	ns
t _{SSTART}	Start condition Setup Time (Only relevant for a repeated Start condition)	0.6	-	-	us
t _{SSTOP}	Stop condition Setup Time	0.6	-	-	us
t _R	Rise Time for data and clock pin	-	-	300	ns
t _F	Fall Time for data and clock pin	-	-	300	ns
t _{IDLE}	Idle Time before a new transmission can start	1.3	-	-	us

I²C interface Timing characteristics

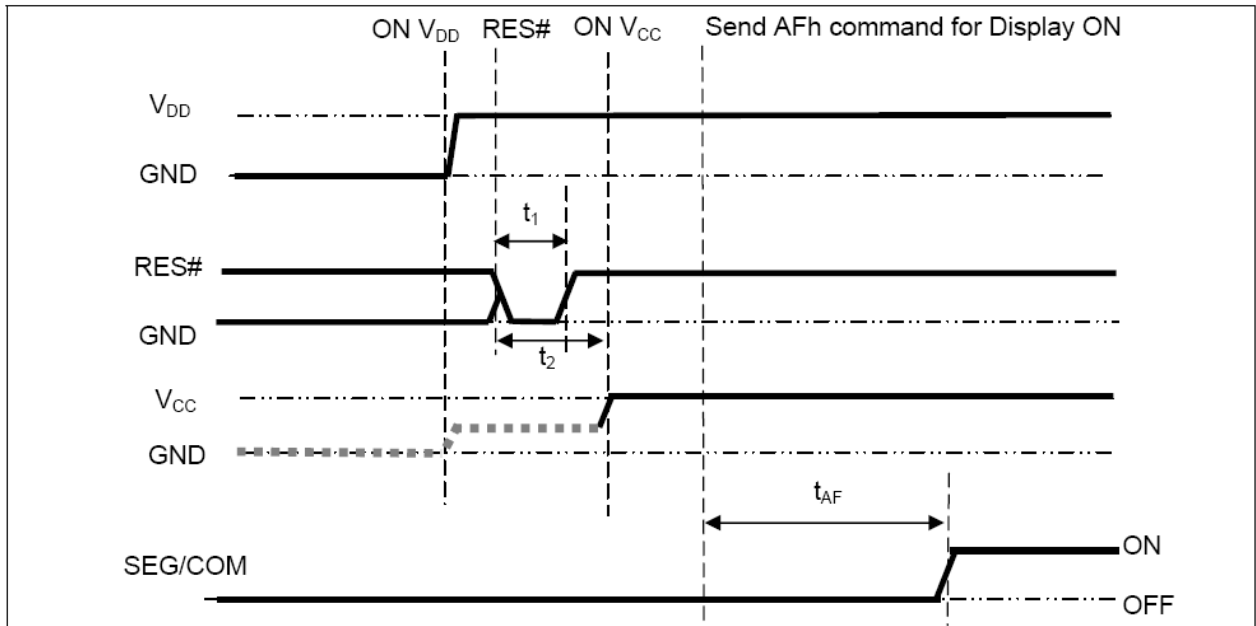


9 Functional Specification and Application Circuit

9.1 Power ON and Power OFF Sequence

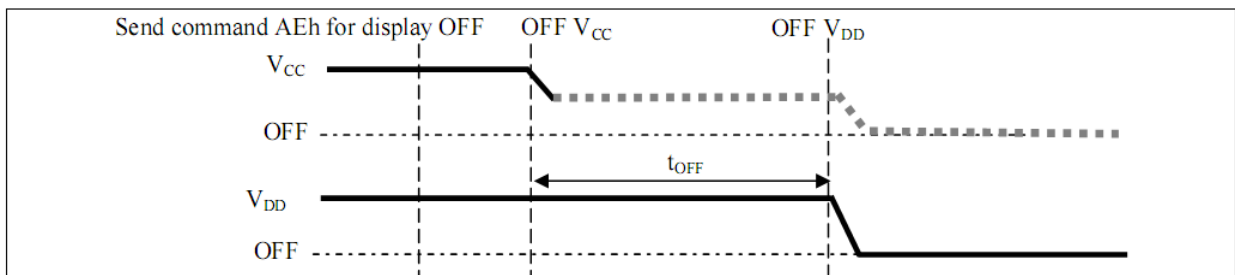
Power ON Sequence:

1. Power ON V_{DD} .
2. After V_{DD} become stable, set RES# pin LOW (logic low) for at least 3 μ s (t_1) and then HIGH (logic high).
3. After set RES# pin LOW (logic low), wait for at least 3 μ s (t_2). Then Power ON V_{CC} . (1)
4. After V_{CC} become stable, send command AFh for display ON. SEG/COM will be ON after 100ms(t_{AF}).



Power OFF Sequence:

1. Send command AEh for display OFF.
2. Power OFF V_{CC} .(1), (2)
3. Wait for t_{OFF} . Power OFF V_{DD} . (where Minimum t_{OFF} =0ms, Typical t_{OFF} =100ms)

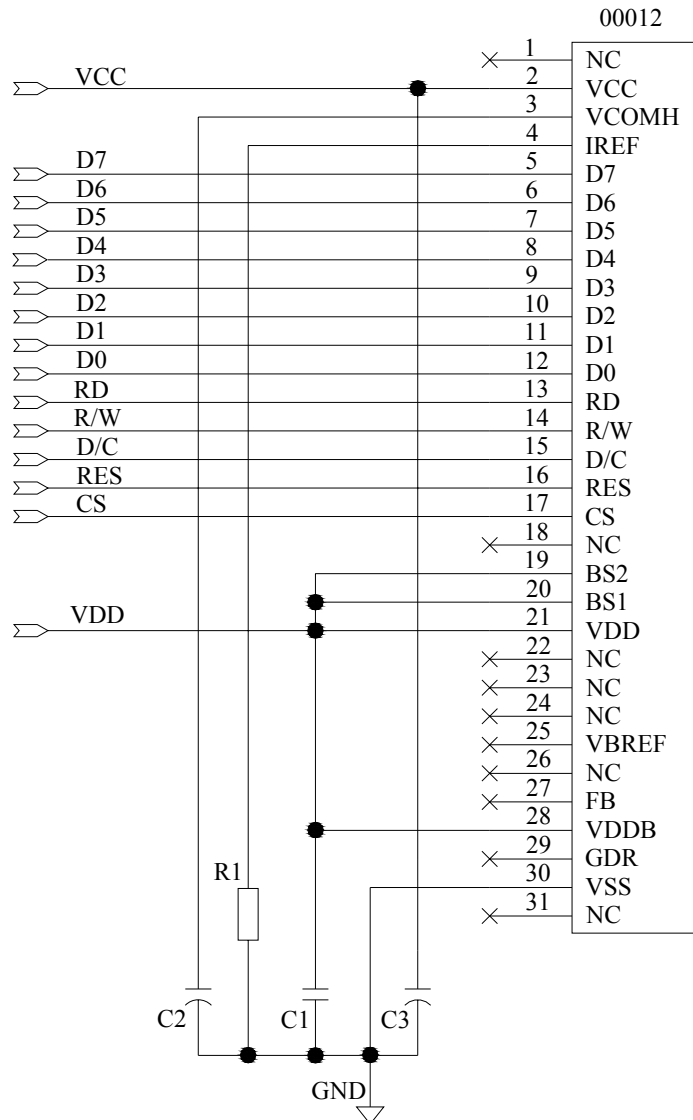


Note:

- (1) Since an ESD protection circuit is connected between V_{DD} and V_{CC} , V_{CC} becomes lower than V_{DD} whenever V_{DD} is ON and V_{CC} is OFF as shown in the dotted line of V_{CC} in above figures.
- (2) V_{CC} should be kept float (disable) when it is OFF.

9.2 Application Circuit

(1).The configuration for 8080-parallel interface mode, external VCC is shown in the following diagram:



Pin connected to MCU interface: D[7:0], RD, R/W, D/C, CS, RES
 GDR, VBREF, FB should be left open.

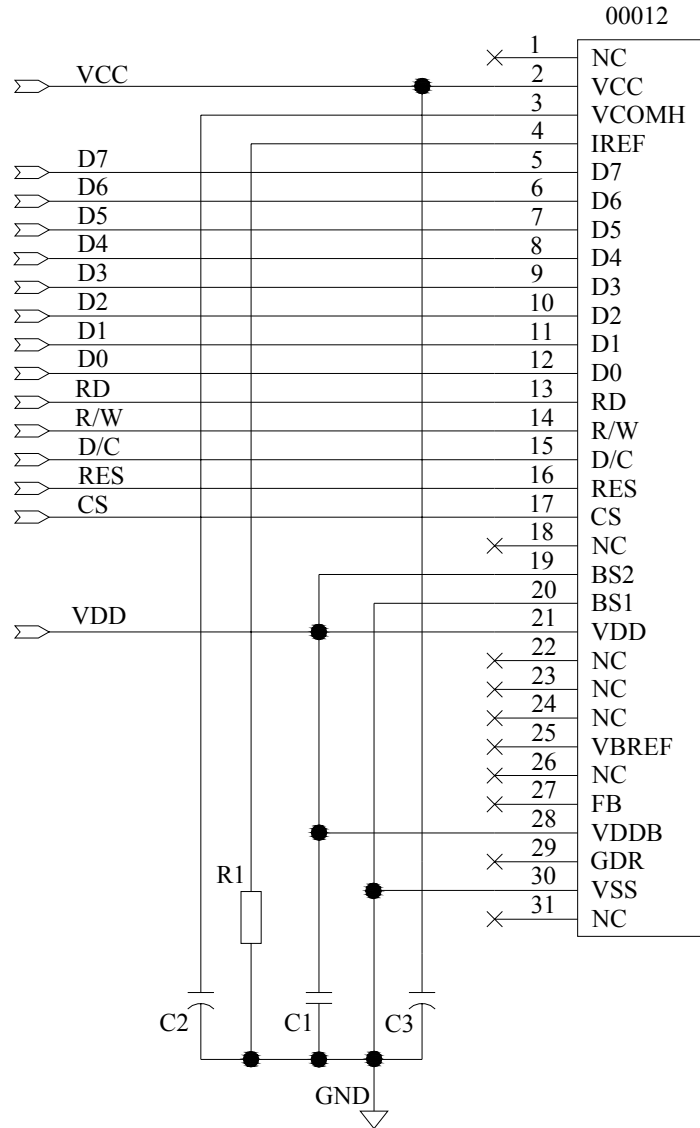
Recommended components

C1 : 0.1uF-0603-X7R±10%.ROHS

C2, C3: 4.7μF/16V.ROHS (Tantalum Capacitors)

R1: 0603 1/10W +/-5% 910Kohm.ROHS

(2).The configuration for 6800-parallel interface mode, external VCC is shown in the following diagram:

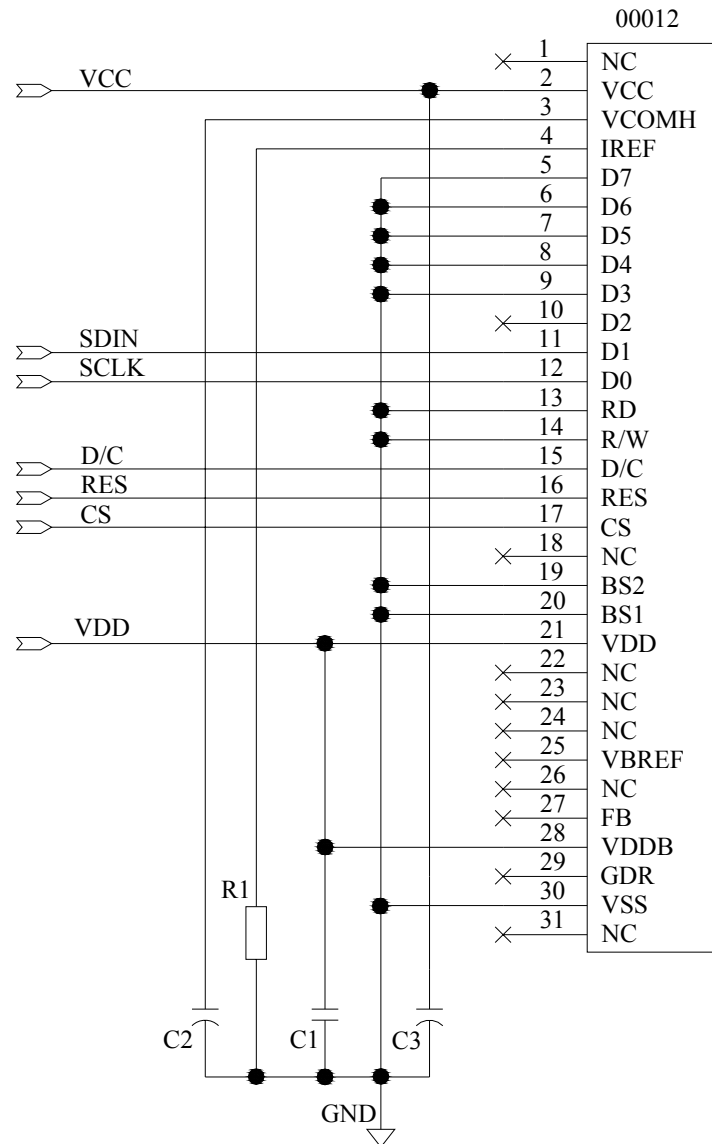


Pin connected to MCU interface: D[7:0], RD, R/W, D/C, CS, RES
 GDR, VBREF, FB should be left open.

Recommended components

- C1 : 0.1uF-0603-X7R±10%.ROHS
- C2, C3: 4.7µF/16V.ROHS (Tantalum Capacitors)
- R1: 0603 1/10W +/-5% 910Kohm.ROHS

(3).The configuration for SPI interface mode, external VCC is shown in the following diagram:



Pin connected to MCU interface: SDIN,SCLK, D/C, CS, RES

GDR, VBREF, FB should be left open.

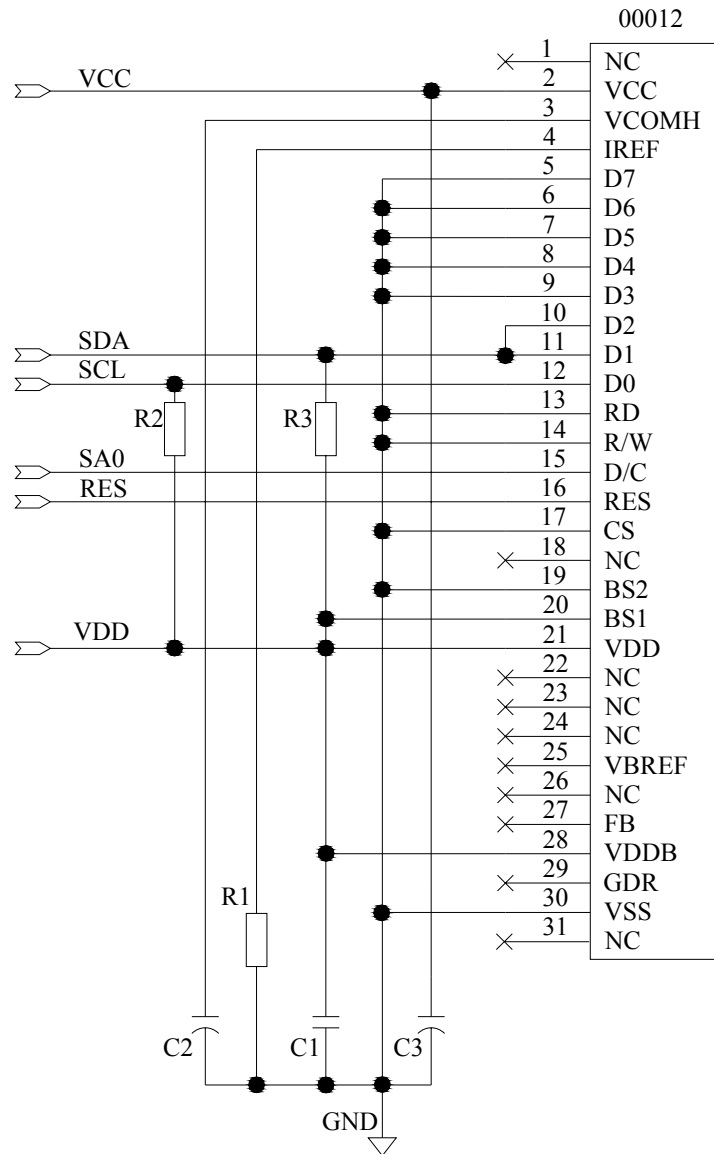
Recommended components

C1 : 0.1uF-0603-X7R±10%.ROHS

C2, C3: 4.7μF/16V.ROHS (Tantalum Capacitors)

R1: 0603 1/10W +/-5% 910Kohm.ROHS

(4).The configuration for I²C interface mode, external VCC is shown in the following diagram:



Pin connected to MCU interface: SDA,SCL, SA0,RES

GDR, VBREF, FB should be left open.

Recommended components

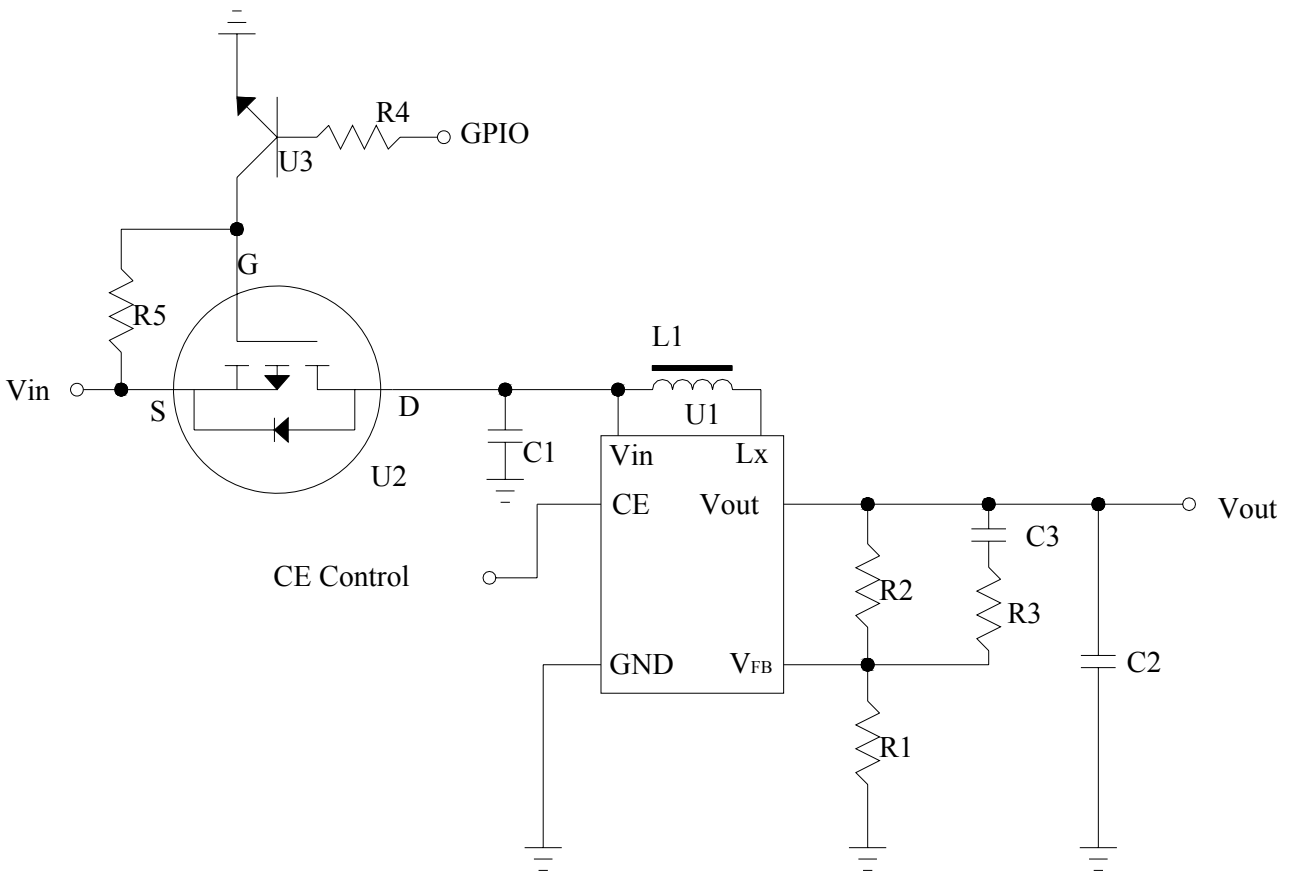
C1 : 0.1uF-0603-X7R±10%.ROHS

C2, C3: 4.7µF/16V.ROHS (Tantalum Capacitors)

R1: 0603 1/10W +/-5% 910Kohm.ROHS

R2,R3: 0603 1/10W +/-5% 10Kohm.ROHS

9.3 External DC-DC application circuit



Recommend component

The C1	: 1 uF-0603-X7R±10%.ROHS
The C2	: 1 uF-0603-X7R±10%.ROHS
The C3	: 220pF-0603-X7R±10%.ROHS
The R1	: 0603 1/10W +/-5% 10Kohm.ROHS
The R2	: 0603 1/10W +/-1% 110Kohm.ROHS
The R3	: 0603 1/10W +/-5% 2Kohm.ROHS
The R4	: 0603 1/10W +/-5% 1Kohm.ROHS
The R5	: 0603 1/10W +/-5% 10Kohm.ROHS
The L1	: 22uH
The U1	: R1200
The U2	: FDN338P
The U3	: 8050

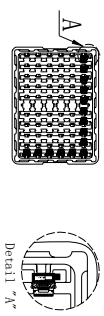
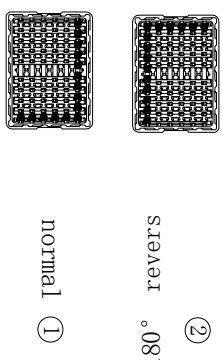
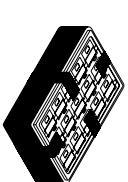
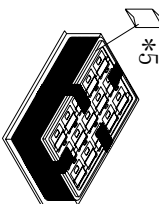
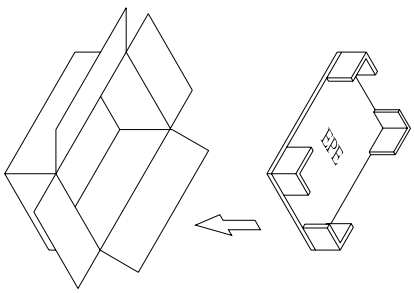
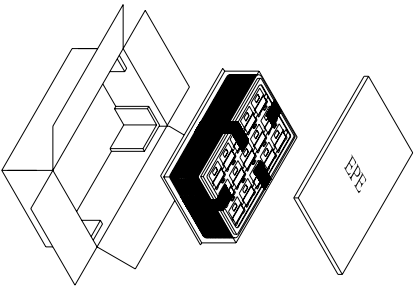
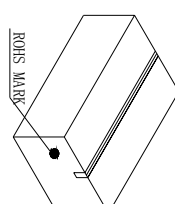
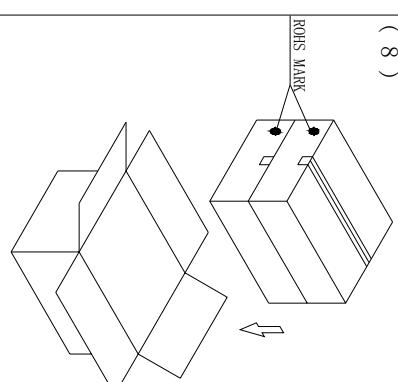
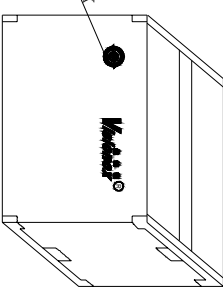

9.4 Display Control Instruction

Refer to SSD1305 IC Specification.

9.5 Recommended Software Initialization

```
void init_program()
{
    write_c(0xae);           // display off
    write_c(0xd5);           //Set Display ClocDivide Ratio/Oscillator Frequency
    write_c(0x50);           //105HZ
    write_c(0xa8);           //Set Multiplex Ratio
    write_c(0x3f);           //set 64mux
    write_c(0xd9);           //Set Pre-charge Period
    write_c(0xf1);           //0xf1
    write_c(0x20);           //Set Memory Addressing Mode
    write_c(0x02);
    write_c(0xa0);           //seg re-map 0->127
    write_c(0xc8);           //COM scan direction COM(N-1)-->COM0
    write_c(0xda);           //Set COM Pins Hardware Configuration
    write_c(0x12);
    write_c(0xd8);           // color_mode_set
    write_c(0x00);           // monochrome mode & normal power mode
    write_c(0x81);           //Set Contrast Control
    write_c(0x5B);           //
    write_c(0xb0);           //Set Page Start Address for Page Addressing Mode
    write_c(0xd3);           //Set Display offset
    write_c(0x00);           //
    write_c(0xa6);           //Display Normal
    write_c(0xa4);           //Entire Display Off
    write_c(0xdb);           //Set VCOMH Level
    write_c(0x34);           //0.77*VCC
    write_c(0xaf);           //display on
}
```

10 Package Specification

Controlled Seal		Packing Process (1) ~ (9)	
<p>(1) TRAY Type:00010-MT1-D</p> 	<p>(2)</p>  <p>TRAY</p> <p>normal ①</p> <p>sever ② 0.081</p>	<p>(3) order ① ② ① ②</p> <p>fix trays with tape</p> <p>208 pcs of 1 small carton</p> <p>1 tray contain 16 pcs</p> <p>13 contained trays, 1 empty tray</p> 	<p>(4) package with plastic bags</p> <p>add five desiccants</p> <p>create a power vacuum</p> <p>*5</p> 
<p>(5)</p> 	<p>(6)</p> 	<p>(7)</p> <p>small carton package</p> <p>L425*W330*L175 mm</p> 	<p>(8)</p> 
<p>(9) 26 contained trays, 2 empty trays,</p> <p>Package quantity products: 416 pcs of 1 big carton</p>  <p>Package finished</p> <p>L450*W350*L360 mm</p>	<p>NOTE:1、 The inner carton and master carton must be sealed with adhesive tape.</p> <p>2、 Fill up the gap with tray.</p> <p>3、 If the customer has special needs with the RoHS makings, the inner carton and master carton need adhesive new RoHS marking at  .</p>		

11 Reliability

11.1 Reliability Test

NO.	ITEM	CONDITION	QUANTITY
1	High Temperature (Non-operation)	85°C,240hrs	4
2	Low Temperature (Non-operation)	-40°C,240hrs	4
3	High Temperature (Operation)	70°C,240hrs	4
4	Low Temperature (Operation)	-40°C,240hrs	4
5	High Temperature / High Humidity (Operation)	60°C,90%RH,240hrs	4
6	Thermal shock (Non-operation)	-40°C~85°C(-40°C/30min;transit/3min;85°C/30min;transit/3min) 1cycle: 66min,30cycles	4
7	Vibration	Frequency: 5~50Hz,0.5G Scan rate: 1 oct/min Time: 2 hrs/axis Test axis: X,Y, Z	1 Carton
8	Drop	Height: 100 cm Sequence: 1 angle, 3 edges and 6 faces	1 Carton

Test and measurement conditions

- All measurements shall not be started until the specimens attain to temperature stability, the stable time is at least 15 minutes.
- The degradation of polarizer is ignored for item 5.
- The tolerance of temperature is $\pm 3^{\circ}\text{C}$, and the tolerance of relative humidity is $\pm 5\%$.

Evaluation criteria

- The function test is OK.
- No observable defects.
- Luminance: $\geq 50\%$ of initial value.
- Current consumption: within $\pm 50\%$ of initial value.

11.2 Lifetime

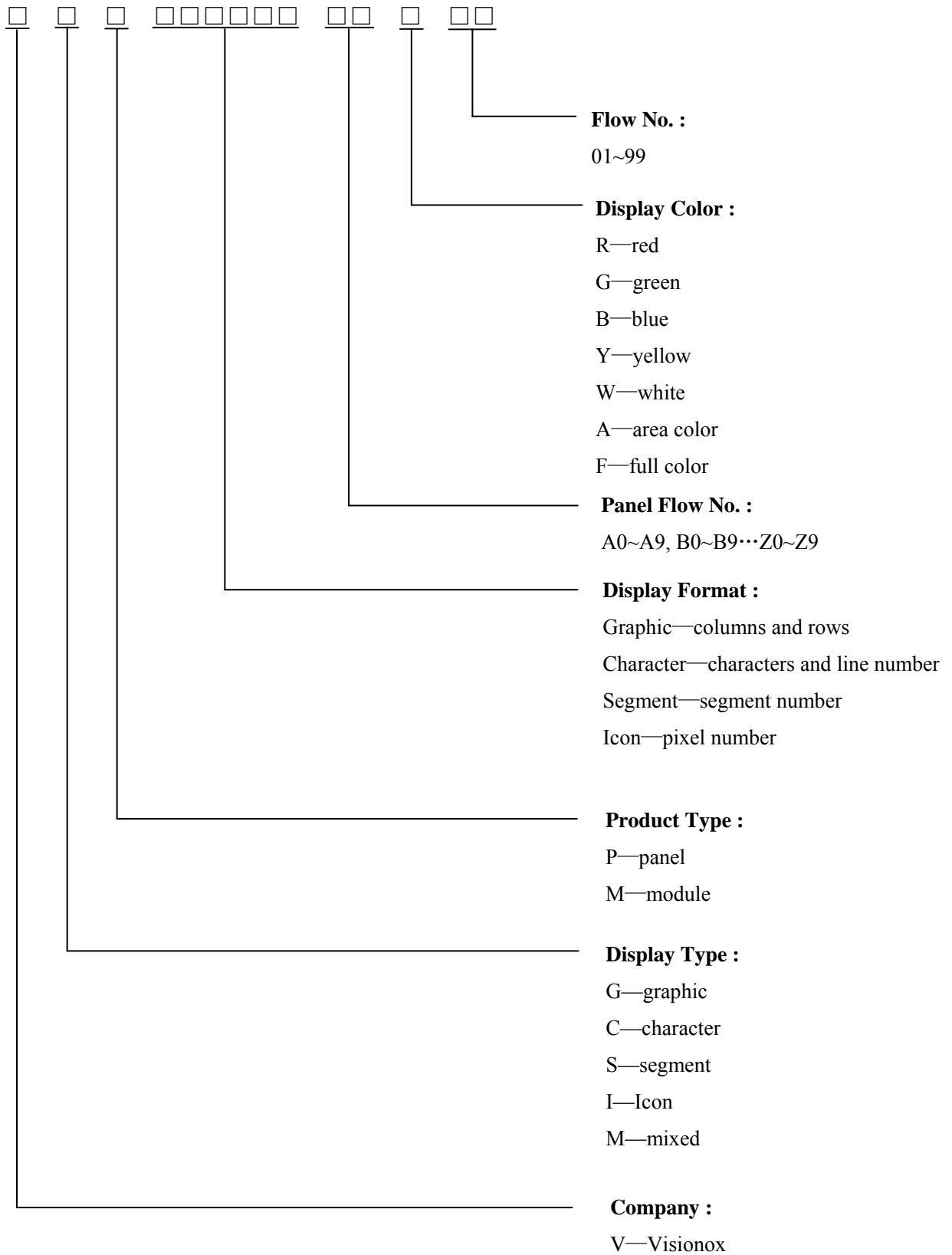
End of lifetime is specified as 50% of initial brightness and the test pattern at operating condition is 50% alternating checkerboard.

ITEM	MIN	MAX	UNIT	CONDITION
Operation Life Time	40,000	-	hrs	60 cd/m ² , 50% alternating checkerboard, 22 \pm 3°C, 55 \pm 15% RH

11.3 Failure Check Standard

After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at 22 \pm 3°C; 55 \pm 15% RH.

12 Illustration of OLED Product Name



13 Outgoing Quality Control Specifications

13.1 Sampling Method

- (1) GB/T 2828.1-2003/ISO2859-1: 1999, inspection level II , normal inspection, single sample inspection
- (2) AQL: Major 0.65; Minor 1.0

13.2 Inspection Conditions

The environmental conditions for test and measurement are performed as follows.

Temperature: 22±3°C

Humidity: 55±15%R.H

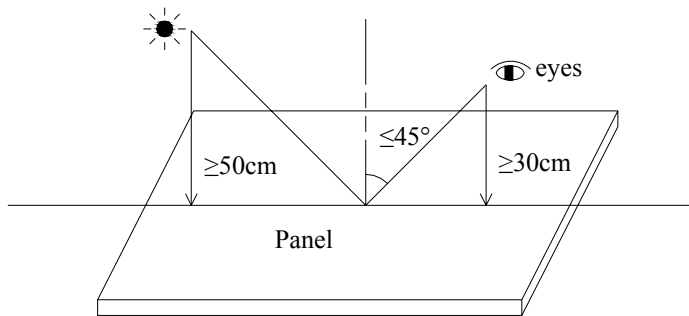
Fluorescent Lamp: 30W

Distance between the Panel & Lamp: ≥50cm

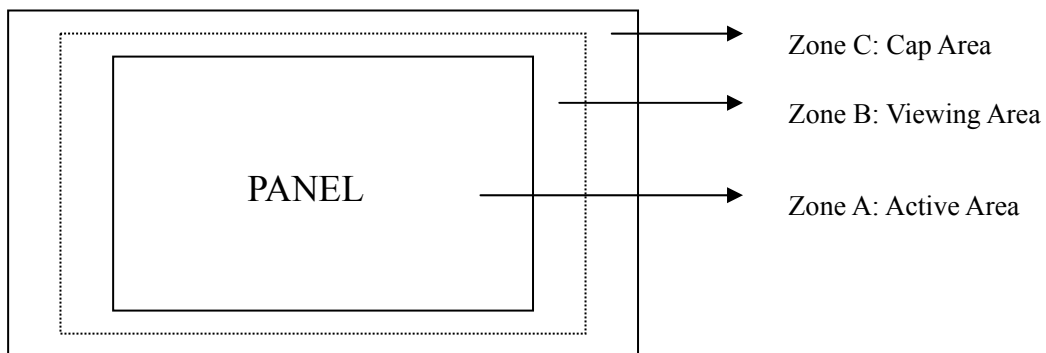
Distance between the Panel & Eyes: ≥30cm

Viewing angle from the vertical in each direction: ≤45°

(See the sketch below)

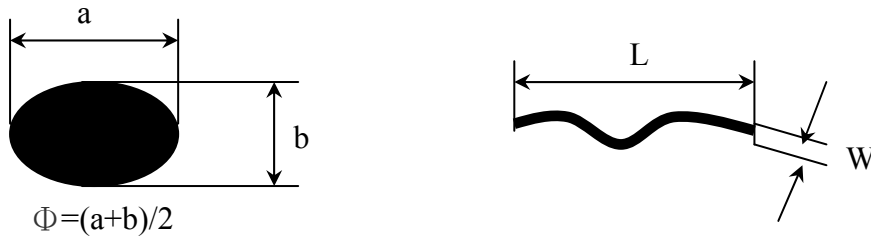


13.3 Quality Assurance Zones

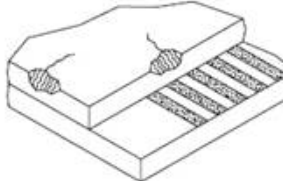


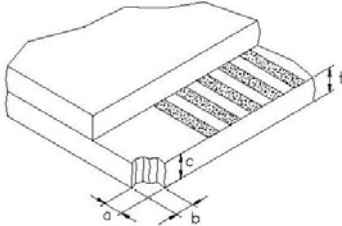
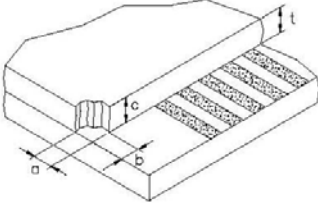
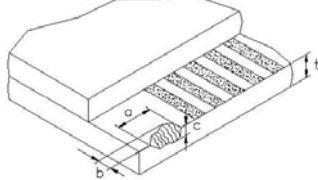
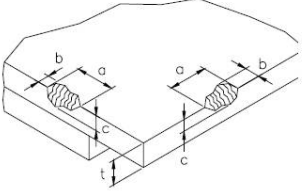
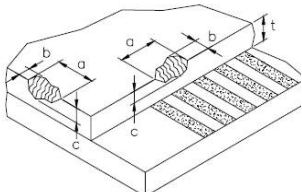
13.4 Inspection Standard

Definition of Φ &L&W (Unit: mm)



I . Appearance Defects

NO.	ITEM	CRITERIA	CLASSIFICATION																
1	Polarizer Black or White spot, Dirty spot, Foreign matter, Dent on the polarizer	<table border="1"> <thead> <tr> <th rowspan="2">Average Diameter (mm)</th> <th colspan="2">Acceptable Number</th> </tr> <tr> <th>Zone A,B</th> <th>Zone C</th> </tr> </thead> <tbody> <tr> <td>$\Phi \leq 0.15$</td> <td>Ignore</td> <td rowspan="3">Ignore</td> </tr> <tr> <td>$0.15 < \Phi \leq 0.30$</td> <td>3</td> </tr> <tr> <td>$\Phi > 0.30$</td> <td>0</td> </tr> </tbody> </table>	Average Diameter (mm)	Acceptable Number		Zone A,B	Zone C	$\Phi \leq 0.15$	Ignore	Ignore	$0.15 < \Phi \leq 0.30$	3	$\Phi > 0.30$	0	Minor				
Average Diameter (mm)	Acceptable Number																		
	Zone A,B	Zone C																	
$\Phi \leq 0.15$	Ignore	Ignore																	
$0.15 < \Phi \leq 0.30$	3																		
$\Phi > 0.30$	0																		
2	Scratch/line on the glass/Polarizer	<table border="1"> <thead> <tr> <th rowspan="2">Width (mm)</th> <th rowspan="2">Length (mm)</th> <th colspan="2">Acceptable Number</th> </tr> <tr> <th>Zone A,B</th> <th>Zone C</th> </tr> </thead> <tbody> <tr> <td>$W \leq 0.03$</td> <td>---</td> <td>Ignore</td> <td rowspan="3">Ignore</td> </tr> <tr> <td>$0.03 < W \leq 0.08$</td> <td>$L \leq 5.0$</td> <td>3</td> </tr> <tr> <td>$W > 0.08$</td> <td>---</td> <td>0</td> </tr> </tbody> </table>	Width (mm)	Length (mm)	Acceptable Number		Zone A,B	Zone C	$W \leq 0.03$	---	Ignore	Ignore	$0.03 < W \leq 0.08$	$L \leq 5.0$	3	$W > 0.08$	---	0	Minor
Width (mm)	Length (mm)	Acceptable Number																	
		Zone A,B	Zone C																
$W \leq 0.03$	---	Ignore	Ignore																
$0.03 < W \leq 0.08$	$L \leq 5.0$	3																	
$W > 0.08$	---	0																	
3	Polarizer Bubble	<table border="1"> <thead> <tr> <th rowspan="2">Average Diameter (mm)</th> <th colspan="2">Acceptable Number</th> </tr> <tr> <th>Zone A,B</th> <th>Zone C</th> </tr> </thead> <tbody> <tr> <td>$\Phi > 0.5$</td> <td>0</td> <td rowspan="3">Ignore</td> </tr> <tr> <td>$0.2 < \Phi \leq 0.5$</td> <td>3</td> </tr> <tr> <td>$\Phi \leq 0.2$</td> <td>Ignore</td> </tr> </tbody> </table>	Average Diameter (mm)	Acceptable Number		Zone A,B	Zone C	$\Phi > 0.5$	0	Ignore	$0.2 < \Phi \leq 0.5$	3	$\Phi \leq 0.2$	Ignore	Minor				
Average Diameter (mm)	Acceptable Number																		
	Zone A,B	Zone C																	
$\Phi > 0.5$	0	Ignore																	
$0.2 < \Phi \leq 0.5$	3																		
$\Phi \leq 0.2$	Ignore																		
4	Any Dirt & Scratch on Polarizer's Protective Film	Ignore for not affect the polarizer.	Acceptable																
5	Glass Crack	 <p>Propagation crack is not acceptable.</p>	Major																

6	Corner Chip	 <p>t= Glass thickness Accept $a \leq 2.0\text{mm}$ or $b \leq 2.0\text{mm}$, $c \leq t$</p>	Minor
7	Corner Chip on Cap Glass	 <p>t= Glass thickness Accept $a \leq 1.5\text{mm}$ or $b \leq 1.5\text{mm}$, $c \leq t$</p>	Minor
8	Chip on Contact Pad	 <p>t= Glass thickness Accept $a \leq 3.0\text{mm}$ or $b \leq 0.8\text{mm}$, $c \leq t$ (on the contact pin) $a \leq 3.0\text{mm}$ or $b \leq 1.5\text{mm}$, $c \leq t$ (outside of the contact pin)</p>	Minor
9	Chip on Face of Display	 <p>t= Glass thickness Accept $a \leq 1.5\text{mm}$ or $b \leq 1.5\text{mm}$, $c \leq t$</p>	Minor
10	Chip on Cap Glass	 <p>t= Glass thickness Accept $a \leq 3.0\text{mm}$ or $b \leq 3.0\text{mm}$, $c \leq t/2$ $a \leq 1.5\text{mm}$ or $b \leq 1.5\text{mm}$, $t/2 \leq c \leq t$</p>	Minor
11	Stain on Surface	Stain removable by soft cloth or air blow is acceptable.	Minor
12	TCP/FPC Damage	<p>(1) Crack, deep scratch, deep hole and deep pressure mark on the TCP/FPC are not acceptable. (2) Terminal lead twisted or broken is not allowable. (3) Copper exposed is not allowed by naked eye inspection.</p>	Minor
13	Dimension Unconformity	Checking by mechanical drawing.	Major

II. Displaying Defects

NO.	Items	Criteria		Classification								
1	Black/White spot Dirty spot Foreign matter	Average Diameter (mm) $\Phi \leq 0.10$ $0.10 < \Phi \leq 0.20$ $\Phi > 0.20$	<table border="1"> <thead> <tr> <th colspan="2" data-bbox="794 371 1259 405">Pieces Permitted</th> </tr> <tr> <th data-bbox="794 405 1003 439">Zone A,B</th> <th data-bbox="1003 405 1259 439">Zone C</th> </tr> </thead> <tbody> <tr> <td data-bbox="794 439 1003 472">Ignore</td> <td data-bbox="1003 439 1259 546" rowspan="3">Ignore</td> </tr> <tr> <td data-bbox="794 472 1003 506">3</td> </tr> <tr> <td data-bbox="794 506 1003 546">0</td> </tr> </tbody> </table>	Pieces Permitted		Zone A,B	Zone C	Ignore	Ignore	3	0	Minor
Pieces Permitted												
Zone A,B	Zone C											
Ignore	Ignore											
3												
0												
2	No Display	Not allowable.		Major								
3	Irregular Display	Not allowable.		Major								
4	Missing Line (row or column)	Not allowable.		Major								
5	Short	Not allowable.		Major								
6	Flicker	Not allowable.		Major								
7	Abnormal Color	Refer to the SPEC.		Major								
8	Luminance NG	Refer to the SPEC.		Major								
9	Over Current	Refer to the SPEC.		Major								

14 Precautions for operation and Storage

14.1 Precautions for Operation

- (1) Since OLED panel is made of glass, do not apply any mechanical shock or impact or excessive force to it when installing the OLED module. Any strong mechanical impact due to falling dropping etc. may cause damage (breakage or cracking).
- (2) The polarizer on the OLED surface is made of soft material and is easily scratched. Please take most care when handing. When the surface of the polarizer of OLED Module is contaminated, please wipe it off gently by using moisten soft cloth with isopropyl alcohol, do not use water, ketone or aromatics. If there is saliva or water on the OLED surface, please wipe it off immediately.
- (3) When handling OLED module, please be sure that the body and the tools are properly grounded. And do not touch I/O pins with bare hands or contaminate I/O pins, it will cause disconnection or defective insulation of terminals.
- (4) Do not attempt to disassemble or process the OLED module.
- (5) OLED module should be used under recommended operating conditions shown in the specification. Since the higher voltage leads to the shorter lifetime, be sure to use the specified operating voltage.
- (6) Foggy dew, moisture condensation or water droplets deposited on surface and contact terminals will cause polarizer stain or damage, the deteriorated display quality and electrochemical reaction then leads to shorter life time and permanent damage to the module probably. Please pay attention to the environmental temperature and humidity.
- (7) An afterimage is created by the difference in brightness between unused dot and the fixed dot, according to the decrease of brightness of the emitting time. Therefore, to avoid having an afterimage, the full set should be thoroughly used instead of using a fixed dot. When the fixed dot emits, an afterimage can be created.
- (8) Flicker could be come out at full on display. And it disappears when frame frequency increase, but brightness decreases too.

14.2 Soldering

- (1) Soldering should be performed only on the I/O terminals.
- (2) Use soldering irons with proper grounding and no leakage.
- (3) Iron: no higher than 300°C and 3~4 sec during soldering.

14.3 Precautions for Storage

- (1) Please store OLED module in a dark place. Avoid exposure to sunlight, the light of fluorescent lamp or any ultraviolet ray.
- (2) Keep the environment temperature between 10°C and 35°C and the relative humidity less than 60%. Avoid high temperature and high humidity.
- (3) Keep the OLED modules stored in the container when shipped from supplier before using them is recommended.
- (4) Do not leave any article on the OLED module surface for an extended period of time.

14.4 Warranty period

Visionox Display Co., Ltd. warrants for a period of 12 months from the shipping date when stored or used under normal condition.